

Modified Form PTO/SB/08A

Substitute for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)		<i>Complete If Known</i>	
		Application Number	10/034,528
		First Named Inventor	Eldridge et al.
		Filing Date	December 27, 2001
		Group Art Unit	2829
		Examiner Name	Paresh H. Patel
No. of Sheets: 1	No. of Refs.: 6	Attorney Docket No.	P6C3-US

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/P.P./	2	JP	05-029406		Mitsubishi Electric Corp	5-Feb-93	Yes	X
/P.P./	3	JP	06-050990		NEC Corporation	25-Feb-94	Yes	X

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/P.P./	5	Korean Supreme Court, 1 st Division, Decision on Appeal, Case No. 2005 Heo 3284 Invalidation of Patent Registration, Phicom v. FormFactor, Inc.	Yes	X
/P.P./	6	Korean Patent Court, 3 rd Division, Decision re: Invalidation, Case No. 2004 Heo 8756 Invalidation of Patent Registration, Phicom v. FormFactor, Inc.	Yes	X

Examiner Signature	/Paresh Patel/	Date Considered	01/05/2008
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* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication

¹Unique citation designation number. ²See attached Kinds of U.S. Patent Documents. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached.

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		Examiner Name	Paresh H. Patel
No. of Sheets: 9	No. of Refs.: 309	Attorney Docket No.	P6C3-US

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	252	EP	0 701 135 B1		Hughes Electronic Corporation	13-Mar-96	Yes	
	253	EP	0 707 310 A1		Hewlett-Packard Company	17-Apr-96	Yes	
	254	EP	0 711 029 B1		Canon Kabushiki Kaisha	8-May-96	Yes	
	255	EP	0 802 419 A2		NEC Corporation	22-Oct-97	Yes	
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	259	JP	01-287484		Hitachi LTD	20-Nov-89	Yes	X
	260	JP	03-081669		Tokyo Kasoode Kenkyosho:KK	8-Apr-91	Yes	X
	261	JP	04-088649		Mitsubishi Electric Corp.	23-Mar-92	Yes	X
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	263	JP	04-111331		Eito Kogyo:KK	13-Apr-92	Yes	X
	264	JP	04-360549		Nippon Denshi Zairo KK	14-Dec-92	Yes	X
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Examiner Signature	/Paresh Patel/	Date Considered	01/05/2008
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* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication

¹Unique citation designation number. ²See attached Kinds of U.S. Patent Documents. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached.

Commonly owned US patent or application whose subject matter may be related to the subject matter of the instance patent application.

Modified Form PTO/SB/08A

Substitute for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)		<i>Complete If Known</i>	
		Application Number	10/034,528
		First Named Inventor	Eldridge et al.
		Filing Date	December 27, 2001
		Group Art Unit	2829
		Examiner Name	Paresh H. Patel
No. of Sheets: 9	No. of Refs.: 364	Attorney Docket No.	P6C3-US

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